



PATENT  
0649-0791P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: YAMAGUCHI et al. Conf.: 7851  
Appl. No.: 09/901,662 Group: 1714  
Filed: July 11, 2001 Examiner: K. WYROZEBSKI LEE  
For: MOLDING COMPOSITION

OK to enter  
2-24-2004

REPLY UNDER 37 C.F.R. § 1.116

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 17, 2004  
(Tuesday after Holiday)

Sir:

In reply to the Office Action dated October 15, 2003, the period for response having been extended one (1) month to February 15, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This Reply contains amendments to the claims and Remarks.

02/19/2004 MAHMED1 00000008 09901662  
01 FC:1251 110.00 DP